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Renesas Electronics Corporation

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# H8/300H Tiny Series

## NMI Interrupt

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### Introduction

By turning on a switch input connected to the  $\overline{\text{NMI}}$  pin, an NMI interrupt is generated, and counting-up of a 16-bit counter which is set in a two-byte variable (counter\_sub) starts.

### Target Device

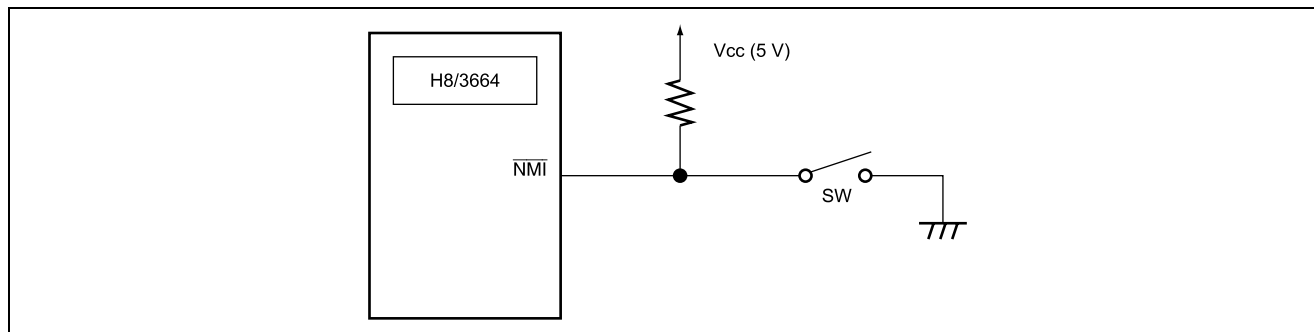
H8/3664

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### 1. Specifications

1. By turning on a switch input connected to the  $\overline{\text{NMI}}$  pin, an NMI interrupt is generated, and counting-up of a 16-bit counter which is set in a two-byte variable (counter\_sub) starts.
2. The NMI interrupt is requested by detection of the falling edge of the input to the  $\overline{\text{NMI}}$  pin.
3. During NMI interrupt handling, counting-up of the 16-bit counter value set in counter\_sub starts.
4. Each time the 16-bit counter set in counter\_sub overflows, an LED is lit or extinguished.
5. The LED is assumed to be connected to the P74 output pin of port 7.
6. Figure 1.1 shows an example of connection of a switch to the  $\overline{\text{NMI}}$  input pin.



**Figure 1.1 LED lighting/extinction operation**

### 2. Description of Functions

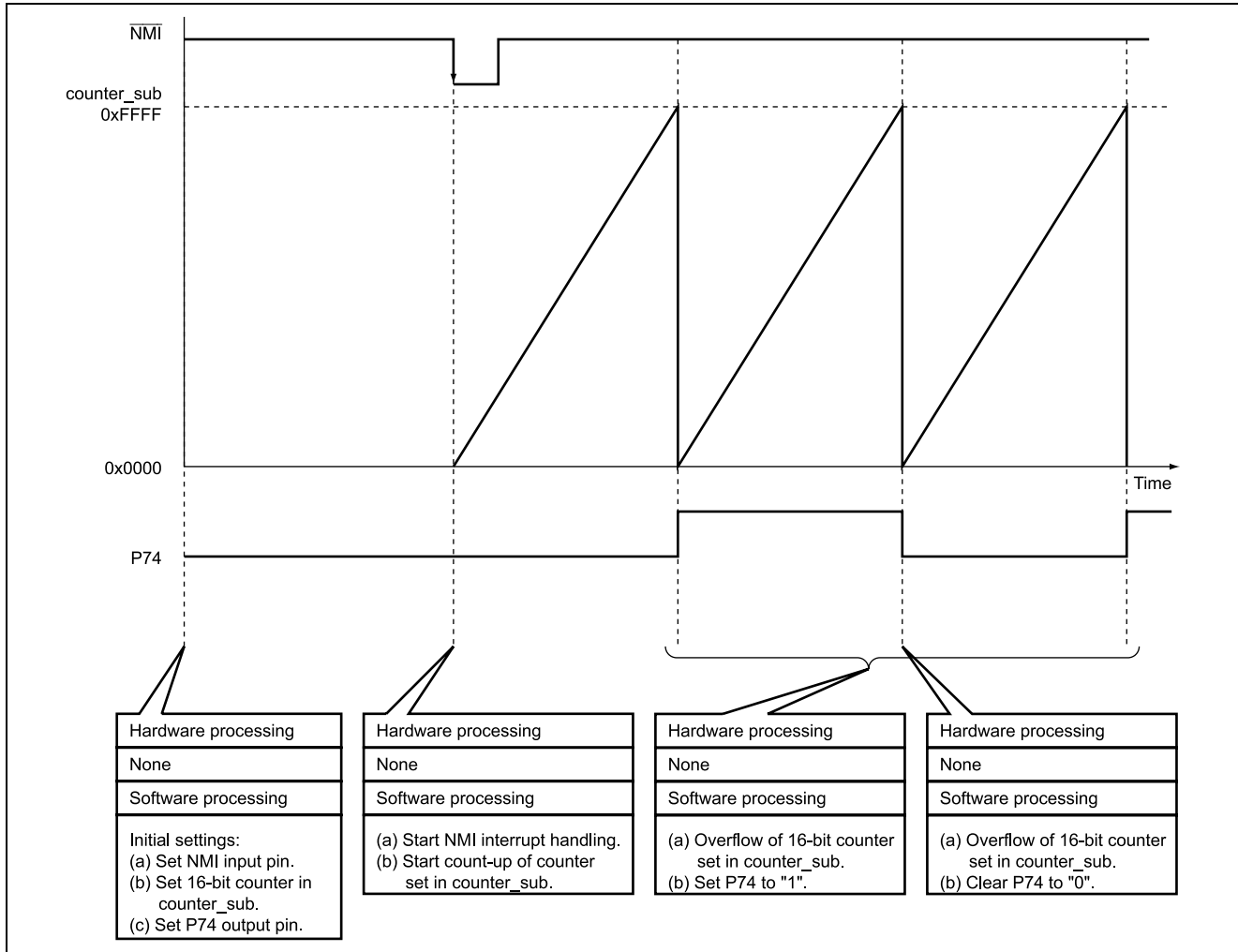
1. In this task example, the counter is started by an NMI interrupt.  
Below, the NMI interrupt is explained.
  - The NMI interrupt is requested by an input signal to the  $\overline{\text{NMI}}$  pin. Rising or falling edge sensing for the NMI interrupt can be specified using the NMIEG bit of the interrupt edge select register 1 (IEGR1).
  - An NMI interrupt request has highest priority and is always accepted regardless of the CCR I bit value.
2. Table 2.1 indicates function allocations in this task example.  
The function allocations indicated in Table 2.1, and operations to light and extinguish the LED connected to the I/O port are performed.

**Table 2.1 Function Allocation**

Function	Function allocation
NMEG0	Sets detection edge direction for $\overline{\text{NMI}}$ pin input
PCR7	Sets P74 output pin function
PDR7	Stores data of P74 output pin
P74	Output pin for LED output

### 3. Description of Operations

Figure 3.1 explains the operation. Through the hardware and software processing shown in the figure, after a NMI interrupt is generated, the LED connected to the I/O port is lit and extinguished.



**Figure 3.1 Explanation of operation to light and extinguish LED connected to the I/O port**

## 4. Description of software

### 4.1 Description of Modules

Table 4.1 explains the modules in this task example.

**Table 4.1 Description of Modules**

Module name	Label name	Function
Main routine	main	Sets direction of input edge for NMI interrupt, sets LED output pin, increments 16-bit counter, and performs LED output
Switch on	NMI	In the NMI interrupt routine, sets SWO NF to 1

### 4.2 Description of Arguments

This sample task uses no arguments.

### 4.3 Description of Internal Registers

The internal registers used in this sample task are described in table 4.2.

**Table 4.2 Description of Internal Registers**

Register Name	Function	Address	Setting
PDR7 P74	Port data register 7 (port data register 74) P74 = 0: The pin P74 output level is low P74 = 1: The pin P74 output level is high	H'FFDA Bit 4	0
PCR7 PCR74	Port control register 7 (port control register 74) PCR74 = 1: The I/O pin P74 functions as an output pin	H'FFEA Bit 4	1
IEGR1 NMIEG	Interrupt edge select register 2 (NMI edge select) NMIEG = 0: Detects the falling edge of the NMI pin input	H'FFF2 Bit 7	0

### 4.4 Description of RAM Used

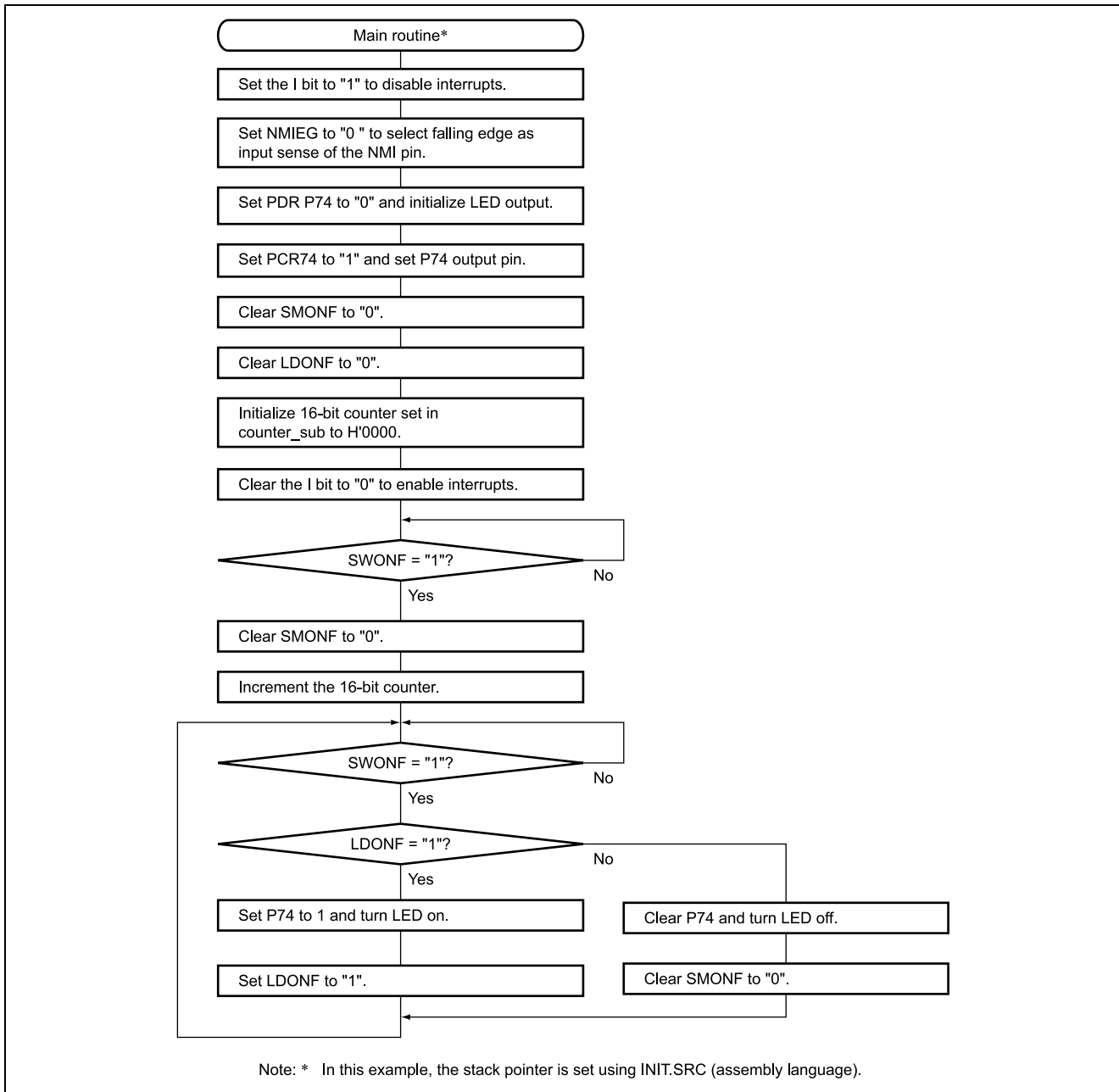
Table 4.3 describes the RAM used in this sample task.

**Table 4.3 Description of RAM**

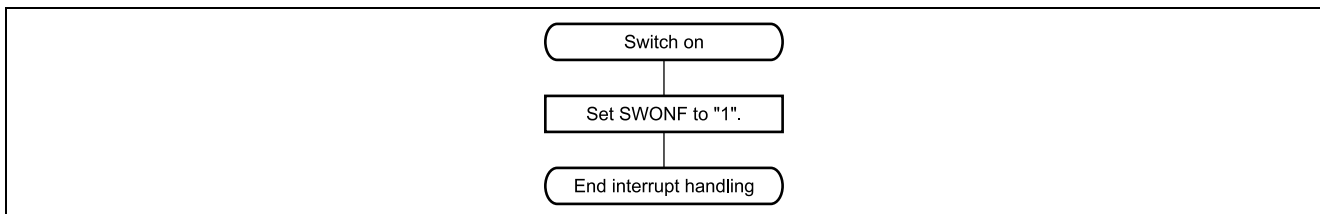
Label Name	Function	Address	Used in
Counter_sub	16-bit up-counter which lights and extinguishes the LED each time overflow occurs	H'FB80	Main routine
USRF	Flag to judge whether switch input is on or off	H'FB82 Bit 0	Main routine Switch on
	LDONF Flag to judge whether LED is on or off	H'FB82 Bit 1	Main routine

## 5. Flowcharts

### 1. Main routine



### 2. NMI interrupt handling routine



## 6. Program Listing

INIT.SRC (Program listing)

```

        .EXPORT  _INIT
        .IMPORT  _main
;
        .SECTION P, CODE
        _INIT:
        MOV.W   #H'FF80,R7
        LDC.B   #B'10000000,CCR
        JMP     @_main
;
        .END

/*****
/*
/* H8/300H Tiny Series -H8/3664-
/* Application Note
/*
/* 'NMI Interrupt function
/*
/* Function
/* : NMI
/*
/* External Clock : 16MHz
/* Internal Clock : 16MHz
/* Sub Clock      : 32.768kHz
/*
*****/

#include <C:\ch38\include\machine.h>

/*****
/* Symbol Definition
*****/

struct BIT {
    unsigned char  b7:1; /* bit7 */
    unsigned char  b6:1; /* bit6 */
    unsigned char  b5:1; /* bit5 */
    unsigned char  b4:1; /* bit4 */
    unsigned char  b3:1; /* bit3 */
    unsigned char  b2:1; /* bit2 */
    unsigned char  b1:1; /* bit1 */
    unsigned char  b0:1; /* bit0 */
};

#define IEGR1      *(volatile unsigned char *)0xFFF2 /* Interrupt Edge select Register1 */
#define IEGR1_BIT  (*(struct BIT *)0xFFF2) /* Interrupt Edge select Register1 */
#define NMIEG      IEGR1_BIT.b7 /* NMI Edge Serect */
#define PCR7       *(volatile unsigned char *)0xFFEA /* Port Control Register 7 */
#define PCR7_BIT  (*(struct BIT *)0xFFEA) /* Port Control Register 7 */
#define PCR74      PCR7_BIT.b4 /* Port Control Register Bit 4 */
#define PDR7       *(volatile unsigned char *)0xFFDA /* Port Data Register 7 */
#define PDR7_BIT  (*(struct BIT *)0xFFDA) /* Port Data Register 7 */
#define P74        PDR7_BIT.b4 /* Port Data Register Bit 4 */

#pragma interrupt (NMI)

```



```

/*****
/*   RAM define
/*****
unsigned int   counter_sub;           /* 16 Bit Up Counter           */
unsigned char USRF;                 /* User Flag Area             */
#define       USRF_BIT   (*(struct BIT *)&USRF)
#define       SWONF     USRF_BIT.b0   /* Swich ON/OFF Judgment Flag  */
#define       LDONF     USRF_BIT.b1   /* LED ON/OFF Judgment Flag   */

extern void _INITSCT();

/*****
/*   Function definition
/*****
extern void   INIT( void );          /* SP Set                      */
extern void   NMI( void );          /* NMI Interrupt Routine       */
void main     ( void );

/*****
/*   Vector Address
/*****
#pragma section V1                  /* VECTOR SECTOIN SET        */
void (*const VEC_TBL1[])(void) = {  /* 0x00 - 0x0f               */
    INIT                             /* 00 Reset                   */
};

#pragma section V2                  /* VECTOR SECTOIN SET        */
void (*const VEC_TBL2[])(void) = {  /* 0x0e - 0x0f               */
    NMI                               /* 07 NMI                      */
};

#pragma section                     /* P                           */
/*****
/*   Main Program
/*****
void main ( void )
{
    _INITSCT();

    NMIEG = 0;                       /* NMI Falling Edge Interrupt */
    P74 = 0;                          /* Port74 "0" Output          */
    PCR74 = 1;                        /* Port74 Output              */
    SWONF = 0;                        /* Swich ON/OFF Judgment Flag Clear */
    LDONF = 0;                        /* LED ON/OFF Judgment Flag Clear */
    counter_sub = 0x0000;             /* 16 Bit Counter Clear      */
    while(SWONF != 1){               /* SWONF = 1 ?                */
        ;
    }
    SWONF = 0;                       /* Clear SWONF                */
}

```

```

while(1){
  do{
    counter_sub++; /* Increment 16bit Counter */
  }while(counter_sub != 0x0000); /* 16bit Counter = H'0000 ? */

  if(LDONF == 1){ /* LDONF = 1 ? */
    P74 = 0; /* Turn Off LED */
    LDONF = 0; /* Clear LDONF */
  }
  else{
    P74 = 1; /* Turn On LED */
    LDONF = 1; /* Set LDONF */
  }
}

/*****
/* NMI Interrupt */
/*****
void NMI( void )
{
  SWONF = 1; /* Set SWONF to 1 */
}

```

### Link address specifications

Section Name	Address
CV1	H'0000
CV2	H'0016
P	H'0100

## Revision Record

Rev.	Date	Description	
		Page	Summary
1.00	Sep.29.03	—	First edition issued

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